Texas Instruments
OMAP4430
Application Processor
45 nm UMC Low Power Process

SRAM Cell Analysis
Texas Instruments OMAP4430 Application Processor
SRAM Cell Analysis

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Table of Contents

1  Overview
   1.1  List of Figures
   1.2  List of Tables
   1.3  Company Profile
   1.4  Introduction
   1.5  Device Summary

2  Device Identification
   2.1  Downstream Product
   2.2  Package
   2.3  Application Processor Die
   2.4  Die Features

3  High Density Six Transistor SRAM Cell
   3.1  Overview
   3.2  Plan-View Analysis High Density 6T SRAM
   3.3  Cross-Sectional Analysis (Perpendicular to Wordline)

4  Low Density Six Transistor SRAM
   4.1  Overview
   4.2  Cross-Sectional Analysis (Perpendicular to Wordline)

5  References

6  Statement of Measurement Uncertainty and Scope Variation

About Chipworks
1 Overview

1.1 List of Figures

2 Device Identification

2.1.1 Downstream Product Packaging Box – Top
2.1.2 Downstream Product – Front
2.1.3 Downstream Product – Back
2.1.4 Downstream Product – Main Board
2.1.5 Downstream Product – Elpida/TI Package-on-Package on Main Board

2.2 Package

2.2.1 Package Top
2.2.2 Package Bottom
2.2.3 Package X-Ray – Plan View
2.2.4 Package X-Ray – Side View

2.3 Application Processor

2.3.1 Application Processor Die – Top Metal Photograph
2.3.2 Die Markings
2.3.3 Application Processor Die Photograph at Poly
2.4 Die Corners

2.4.1 Die Corner A
2.4.2 Die Corner B
2.4.3 Die Corner C
2.4.4 Die Corner D
2.4.5 Minimum Pitch Flip-Chip Pads
2.4.6 Die Photograph at Poly – Memory Locations
2.4.7 Latches at Poly

3 High Density Six Transistor SRAM Cell

3.1.1 6T SRAM
3.2.1 High Density 6T SRAM at Metal 3
3.2.2 High Density 6T SRAM at Metal 2
3.2.3 High Density 6T SRAM at Metal 1
3.2.4 High Density 6T SRAM at Poly
3.2.5 High Density 6T SRAM at Diffusion
3.3.1 High Density SRAM NMOS Transistor Overview
3.3.2 High Density SRAM NMOS Transistors
3.3.3 High Density SRAM PMOS Transistor Overview
3.3.4 High Density SRAM PMOS Pull-up Transistor

4 Low Density Six Transistor SRAM

4.1.1 Low Density 6T SRAM at Metal 3
4.1.2 Low Density 6T SRAM at Metal 2
4.1.3 Low Density 6T SRAM at Metal 1
4.1.4 Low Density 6T SRAM at Poly
4.1.5 Low Density 6T SRAM at Diffusion
4.2.1 Low Density 6T SRAM NMOS Transistor Overview
4.2.2 Low Density 6T SRAM NMOS Transistors
4.2.3 Low Density 6T SRAM PMOS Transistor Overview
4.2.4 Low Density 6T SRAM PMOS Transistor
1.2 List of Tables

1. Overview
1.4.1 Device Identification
1.5.1 Device Summary

3. High Density Six Transistor SRAM Cell
3.2.1 High Density SRAM Dimensions

4. Low Density Six Transistor SRAM
4.1.1 Low Density SRAM Dimensions
Texas Instruments OMAP4430 Application Processor

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